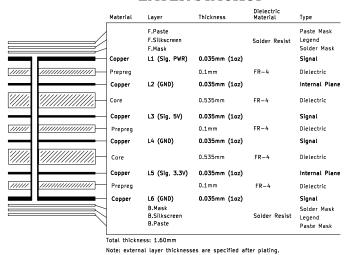
Rapid-CoreX Fabrication Document

Top Fabrication (Scale 1:1)

LAYER STACKUP



FABRICATION NOTES (UNLESS OTHERWISE SPECIFIED)

- OUTLINE DEFINED IN SEPARATE GERBER FILE WITH "Edge_Cuts.GBR" SUFFIX.
 DIMENSIONS OF CIRCUMSIZED RECTANGLE SHOWN ON THIS DWG FOR REF ONLY.
- 2) SEE SEPARATE DRILL FILES WITH ".DRL" SUFFIX FOR HOLE LOCATIONS. SELECTED HOLE LOCATIONS SHOWN ON THIS DWG FOR REF ONLY.
- 3) CONFIRM TRACE WIDTHS AND SPACINGS.

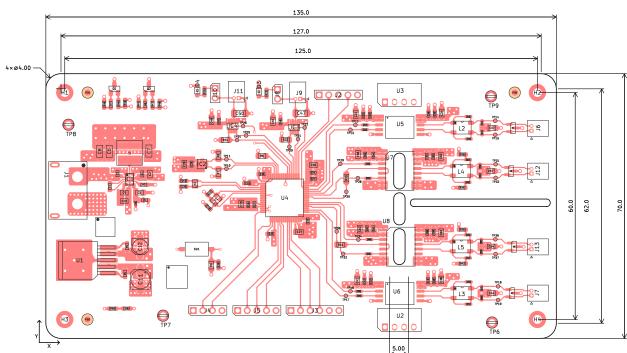
BOARD CHARACTERISTICS

Edge card connectors:

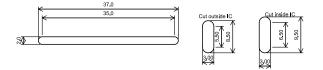
Copper Layer Count: 6 Board Thickness: 1.60 mm

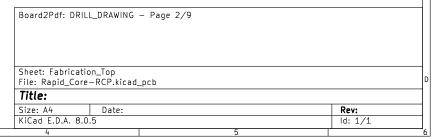
Board overall dimensions: 135.00 mm \times 70.00 mm

Min track/spacing:0.22 mm / 0.20 mmMin hole diameter:0.30 mmCopper Finish:HAL lead-freeImpedance Control:NoCastellated pads:NoPlated Board Edge:No



All dimensions are in millimeters unless otherwise specified.



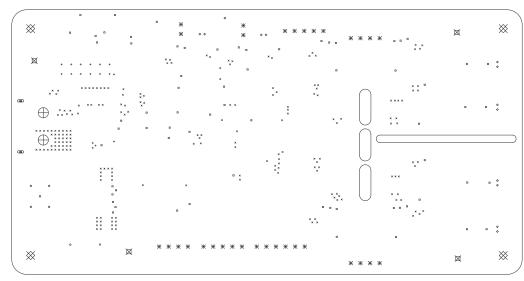




0.35mm 207

0.60mm 2(slots)

2.20mm 4 2.70mm 2



F.Cu (Signal) •000 Board2Pdf: DRILL_DRAWING — Page 2/9 Sheet: L1 File: Rapid_Core-RCP.kicad_pcb Title: Size: A4 KiCad E.D.A. 8.0.5 **Rev:** Id: 1/1

